Drilling flexible forms, blind and hole drilling, cutting, in- and on-glass markings, structuring, removal of coatings - the all-in-one solution from MDI Advanced Processing GmbH

LD 500: Glass processing for small substrates

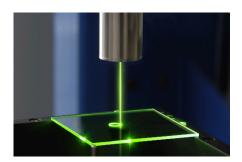


The glass processing systems of the LD series from MDI Advanced Processing GmbH offer high-quality processing of brittle materials for a variety of industrial applications due to the laser technology used (532nm).

Technology and process

The "Green Laser" enables drilling of flexible shapes, blind and hole drilling, cutting, marking in and on the glass, structuring and removal of coatings in one system. The process is based on a solid-state laser that emits green light with a wavelength of 532 nm, maximum precision for your application.





substrate size: max. 500 x 500 mmglass thckness: 0.3 – 10 mm

• position/ repeatability: ± 0.1 mm / ± 0.05 mm

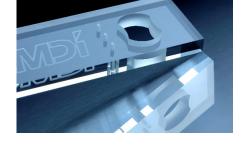
dimension (L x B x H): min. 1.800 x 1.400 x 2.100 mm

Options

- customization
- various table and clamping designs
- software tools (DXF-converter)

MDI Advanced Processing GmbH would be happy to provide you with detailed information about the LD series and show you the advantages for your company.

Please contact us if you have any questions or are interested in a live demonstration of our technologies and products.



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Drilling flexible forms, blind and hole drilling, cutting, in- and on-glass markings, structuring, removal of coatings - the all-in-one solution from MDI Advanced Processing GmbH

LD 650: Glass processing for medium substrates

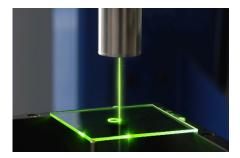


The glass processing systems of the LD series from MDI Advanced Processing GmbH offer high-quality processing of brittle materials for a variety of industrial applications due to the laser technology used (532nm).

Technology and process

The "Green Laser" enables drilling of flexible shapes, blind and hole drilling, cutting, marking in and on the glass, structuring and removal of coatings in one system. The process is based on a solid-state laser that emits green light with a wavelength of 532 nm, maximum precision for your application.





substrate size: max. 950 x 650 mm
glass thickness: 0.3 – 10 mm

position/repeatability : ± 0.05 mm / ± 0.25 mm
dimensions (L x B x H): min. 2.800 x 1.900 x 2.100 mm

Options

customization

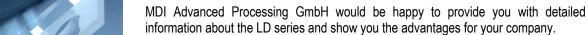
various table and clamping designs

software tools (DXF-converter)

alignment System

• laser power measurement

automization



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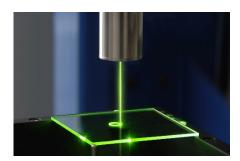
LD 2000: Glasprocessing for large substrates



The glass processing systems of the LD series from MDI Advanced Processing GmbH offer high-quality processing of brittle materials for a variety of industrial applications due to the laser technology used (532nm).

Technology and process

The "Green Laser" enables drilling of flexible shapes, blind and hole drilling, cutting, marking in and on the glass, structuring and removal of coatings in one system. The process is based on a solid-state laser that emits green light with a wavelength of 532 nm, maximum precision for your application.



Technical data

substrate size: max. 2000 x 1500 mm

glass thickness: 0.3 – 10 mm

position/repeatability: $\pm 0.1 \text{ mm} / \pm 0.05 \text{ mm}$

dimensions (L x B x H): min. 3.500 x 3.300 x 2.100 mm



customization

various table and clamping designs

software tools (DXF-converter)

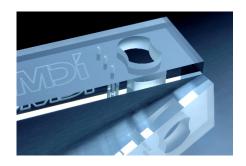
alignment System

laser power measurement

automization

MDI Advanced Processing GmbH would be happy to provide you with detailed information about the LD series and show you the advantages for your company.

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